

PRODUCTION CAPABILITY

ITEM	MANUFACTURING CAPABILITY
Layers	1-30 Layers
Max. Board Size	800*500mm
Thickness	0.2-7.0mm
Copper Thickness	0.33-12 oz
Min. Line Width & Spacing	3mil/2.5mil
Min. Drill Size	4mil
Min. Hole to Track Spacing	5mil
Impedance Tolerance	+/-5 OHM(<=50 OHM),Advance +/-5%
Outline Size Tolerance	+/-4mil
Merterials	Sheng Yi S1141,S1155(Halogen free) ITEQ IT180A , S1000-2 ,S1165(Halogen free), PCL-370HR,FR408,FR406,FR408H ,N4000-13, VT901, Rogers4350B,Rogers4003C
Surface Finish	HASL lead Free , ENIG, Immersion silver , Immersion Tin ,OSP,HARD GOLD,Soft Gold, Gold finger, ENEPIG, Leaded HASL